

# Initial Product/Process Change Notification Document #:IPCN25284X

Issue Date:21 Mar 2023

Title of Change:	NCP308MTADJTBG Fab	NCP308MTADJTBG Fab Capacity Addition at onsemi Aizu Japan			
Proposed First Ship date:	30 Jul 2023 or earlier if approved by customer				
Contact Information:	Contact your local onse	Contact your local onsemi Sales Office or Mat.Hilton@onsemi.com			
PCN Samples Contact:	Contact your local onsemi Sales Office.  Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change.  Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.				
Type of Notification:	advance notification al change details and dev The completed qualific Product/Process Chang Product/Process Chang	This is an Initial Product/Process Change Notification (IPCN) sent to customers. An IPCN is an advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan. The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact < PCN.Support@onsemi.com>			
Marking of Parts/ Traceability of Change:	There is no change to t number.	There is no change to the die marking. Traceability will be maintained by the manufacturing lot number.			
Change Category:	Wafer Fab Change	Wafer Fab Change			
Change Sub-Category(s):	Manufacturing Site Ad	Manufacturing Site Addition			
Sites Affected:					
onsemi Sites		External Foundry/Subcon Sites			
onsemi Aizu, Japan		None			
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### **Description and Purpose:**

This initial notification announces the intention to qualify the onsemi Aizu Japan fab for the NCP308MTADJTBG part number. The NCP308MTADJTBG is currently fabricated in the onsemi Gresham Oregon FAB. Upon approval of the FPCN, the NCP308MTADJTBG may be fabricated in either onsemi Gresham Oregon or onsemi Aizu Japan as shown in the table below.

	From	То
Fab Site	onsemi, Gresham Oregon, USA	onsemi, Gresham Oregon, USA or onsemi Aizu, Japan

Aizu die will have a narrower scribe width.

There are no product material changes as a result of this change.

There is no product marking change as a result of this change.

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**Qualification Plan:** 

**QV DEVICE NAME: NCP308MTADJTBG** 

RMS: S87946

PACKAGE: WDFN6 2\*2

Test	Specification	Condition	Interval
High Temperature Operating Life	High Temperature Operating Life JESD22-A108		1008 hrs
High Temperature Storage Life	JESD22-A103	Ta= 150°C	1008 hrs
Preconditioning	J-STD-020 JESD-A113	MSL 1 @ 260 °C	
Temperature Cycling	JESD22-A104	Ta= -65°C to +150°C	500 cyc
Highly Accelerated Stress Test	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs
Unbiased Highly Accelerated Stress Test JESD22-A118		130°C, 85% RH, 18.8psig, unbiased	96 hrs

Estimated date for qualification completion: 14 April 2023

#### **List of Affected Parts:**

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the PCN Customized Portal.

Part Number	Qualification Vehicle	
NCP308MTADJTBG	NCP308MTADJTBG	

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### **Appendix A: Changed Products**

PCN#: IPCN25284X

**Issue Date: Mar 21, 2023** 

DIKG: DIGI-KEY

Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
NCP308MTADJTBG		NCP308MTADJTBG	NA	